

January 2011

Single-Channel: 6N137, HCPL2601, HCPL2611 Dual-Channel: HCPL2630, HCPL2631 High Speed 10MBit/s Logic Gate Optocouplers

Features

- Very high speed 10 MBit/s
- Superior CMR 10 kV/µs
- Double working voltage-480V
- Fan-out of 8 over -40°C to +85°C
- Logic gate output
- Strobable output
- Wired OR-open collector
- U.L. recognized (File # E90700)

Applications

- Ground loop elimination
- LSTTL to TTL, LSTTL or 5-volt CMOS
- Line receiver, data transmission
- Data multiplexing
- Switching power supplies
- Pulse transformer replacement
- Computer-peripheral interface

Description

The 6N137, HCPL2601, HCPL2611 single-channel and HCPL2630, HCPL2631 dual-channel optocouplers consist of a 850 nm AlGaAS LED, optically coupled to a very high speed integrated photo-detector logic gate with a strobable output. This output features an open collector, thereby permitting wired OR outputs. The coupled parameters are guaranteed over the temperature range of -40°C to +85°C. A maximum input signal of 5mA will provide a minimum output sink current of 13mA (fan out of 8).

An internal noise shield provides superior common mode rejection of typically 10kV/ μ s. The HCPL2601 and HCPL2631 has a minimum CMR of 5kV/ μ s. The HCPL2611 has a minimum CMR of 10kV/ μ s.



Package Outlines



| Truth Table | (Positive Logic) |
|--------------------|------------------|
|--------------------|------------------|

| Input | Enable | Output |
|-------|--------|--------|
| Н | Н | L |
| L | Н | Н |
| Н | L | Н |
| L | L | Н |
| Н | NC | L |
| L | NC | Н |

Absolute Maximum Ratings (T_A = 25°C unless otherwise specified)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Param | Value | Units | |
|-----------------------------------|--|-----------------------------|----------------|----|
| T _{STG} | Storage Temperature | | -55 to +125 | °C |
| T _{OPR} | Operating Temperature | | -40 to +85 | °C |
| T _{SOL} | Lead Solder Temperature (for wave s | oldering only)* | 260 for 10 sec | °C |
| EMITTER | | | 1 | |
| ١ _F | DC/Average Forward | Single Channel | 50 | mA |
| | Input Current | Dual Channel (Each Channel) | 30 | |
| V _E | Enable Input Voltage Not to Exceed V_{CC} by more than 500mV | Single Channel | 5.5 | V |
| V _R | Reverse Input Voltage | Each Channel | 5.0 | V |
| PI | Power Dissipation | Single Channel | 100 | mW |
| | | Dual Channel (Each Channel) | 45 | |
| DETECTOR | | | | |
| V _{CC} (1 minute max) | Supply Voltage | | 7.0 | V |
| Ι _Ο | Output Current | Single Channel | 50 | mA |
| | | Dual Channel (Each Channel) | 50 | |
| V _O | Output Voltage | Each Channel | 7.0 | V |
| Po | Collector Output | Single Channel | 85 | mW |
| | Power Dissipation | Dual Channel (Each Channel) | 60 | |

*For peak soldering reflow, please refer to the Reflow Profile on page 11.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

| Symbol | Parameter | Min. | Max. | Units | |
|--|---------------------------|------|-----------------|-------|--|
| I _{FL} | Input Current, Low Level | 0 | 250 | μA | |
| I _{FH} | Input Current, High Level | *6.3 | 15 | mA | |
| V _{CC} Supply Voltage, Output | | 4.5 | 5.5 | V | |
| V _{EL} | Enable Voltage, Low Level | 0 | 0.8 | V | |
| V _{EH} Enable Voltage, High Level | | 2.0 | V _{CC} | V | |
| T _A Low Level Supply Current | | -40 | +85 | °C | |
| Ν | Fan Out (TTL load) | | 8 | | |

*6.3mA is a guard banded value which allows for at least 20% CTR degradation. Initial input current threshold value is 5.0mA or less.

| Symbol | Parameter | Test Condi | itions | Min. | Typ.* | Max. | Unit |
|-------------------------------|--|---|----------------------------------|------|-------|------|-------|
| EMITTER | | | | | | | |
| V _F | Input Forward Voltage | I _F = 10mA | | | | 1.8 | V |
| | | | $T_A = 25^{\circ}C$ | | 1.4 | 1.75 | |
| B _{VR} | Input Reverse Breakdown Voltage | I _R = 10μΑ | | 5.0 | | | V |
| C _{IN} | Input Capacitance | $V_F = 0$, f = 1MHz | | | 60 | | pF |
| $\Delta V_{F} / \Delta T_{A}$ | Input Diode Temperature Coefficient | I _F = 10mA | | | -1.4 | | mV/°C |
| DETECTOR | 2 | | | | 1 | | |
| I _{CCH} | High Level Supply Current | $V_{CC} = 5.5V, I_F = 0mA,$ | Single Channel | | 7 | 10 | mA |
| | | $V_{E} = 0.5V$ | Dual Channel | 6 | 10 | 15 | |
| I _{CCL} | Low Level Supply Current | Single Channel | $V_{CC} = 5.5V,$ $I_F = 10mA$ | | 9 | 13 | mA |
| | | Dual Channel | $V_{E} = 0.5V$ | | 14 | 21 | |
| I _{EL} | Low Level Enable Current | $V_{\rm CC} = 5.5 V, V_{\rm E} = 0.5 V$ | | | -0.8 | -1.6 | mA |
| I _{EH} | High Level Enable Current | $V_{CC} = 5.5V, V_E = 2.0V$ | | | -0.6 | -1.6 | mA |
| V _{EH} | High Level Enable Voltage | V _{CC} = 5.5V, I _F = 10mA | | 2.0 | | | V |
| V _{EL} | Low Level Enable Voltage | $V_{\rm CC} = 5.5 \text{V}, I_{\rm F} = 10 \text{mA}^{(3)}$ | | | | 0.8 | V |

Switching Characteristics ($T_A = -40^{\circ}C$ to $+85^{\circ}C$, $V_{CC} = 5V$, $I_F = 7.5$ mA unless otherwise specified)

| Symbol | AC Characteristics | Test Co | nditions | Min. | Тур.* | Max. | Unit |
|---|---|---|---|--------|--------|-----------|------|
| T _{PLH} | Propagation Delay Time to Output HIGH Level | $R_L = 350\Omega,$ $C_L = 15pF^{(4)}$ (Fig. 12) | T _A = 25°C | 20 | 45 | 75 100 | ns |
| T _{PHL} | Propagation Delay Time to Output LOW | $T_A = 25^{\circ}C^{(5)}$ $R_1 = 350\Omega, C_1 = 15pF$ (| Fig. 12) | 25 | 45 | 75 100 | ns |
| | Level | | 19.12) | | | 100 | |
| IT _{PHL} –T _{PLH} I | Pulse Width Distortion | $(R_L = 350\Omega, C_L = 15pF)$ | (Fig. 12) | | 3 | 35 | ns |
| t _r | Output Rise Time (10–90%) | $R_{L} = 350\Omega, C_{L} = 15pF^{(6)}$ | $R_L = 350\Omega, C_L = 15pF^{(6)}$ (Fig. 12) | | 50 | | ns |
| t _f | Output Rise Time (90–10%) | $R_L = 350\Omega, C_L = 15pF^{(7)}$ (Fig. 12) | | | 12 | | ns |
| t _{ELH} | Enable Propagation Delay Time to Output HIGH Level | I_F = 7.5mA, V_{EH} = 3.5V, R_L = 350Ω, C_L = 15pF ⁽⁸⁾ (Fig. 13) | | | 20 | | ns |
| t _{EHL} | Enable Propagation Delay Time to Output LOW Level | I_F = 7.5mA, V_{EH} = 3.5V, R_L = 350Ω, C_L = 15pF ⁽⁹⁾ (Fig. 13) | | | 20 | 6 | ns |
| ICM _H I | Common Mode | $T_A = 25^{\circ}C, V_{CM} = 50V$ | 6N137, HCPL2630 | | 10,000 | | V/µs |
| | Transient Immunity (at Output HIGH Level) | | HCPL2601, HCPL2631 | 5000 | 10,000 | | |
| | | $ V_{CM} = 400V$ | HCPL2611 | 10,000 | 15,000 | | V/µs |
| ICMLI | Common Mode | $R_L = 350\Omega, I_F = 7.5mA,$ | 6N137, HCPL2630 | | 10,000 | |] |
| Transient Immunity (at Output LOW Level) | V_{OL} (Max.) = 0.8V, $T_A = 25^{\circ}C^{(11)}$ (Fig. 14) | HCPL2601, HCPL2631 | 5000 | 10,000 | | | |
| | | $ V_{CM} = 400V$ | HCPL2611 | 10,000 | 15,000 | | |

Electrical Characteristics (Continued)

| Symbol | DC Characteristics | Test Conditions | Min. | Тур.* | Max. | Unit |
|-----------------|---------------------------|--|------|-------|------|------|
| I _{ОН} | HIGH Level Output Current | $V_{CC} = 5.5V, V_O = 5.5V,$ $I_F = 250\mu A, V_E = 2.0V^{(2)}$ | | | 100 | μA |
| V _{OL} | LOW Level Output Current | $V_{CC} = 5.5V, I_F = 5mA, V_E = 2.0V,$ $I_{CL} = 13mA^{(2)}$ | | .35 | 0.6 | V |
| I _{FT} | Input Threshold Current | $V_{CC} = 5.5V, V_O = 0.6V, V_E = 2.0V, I_{OL} = 13mA$ | | 3 | 5 | mA |

Transfer Characteristics (T_A = -40 to +85°C unless otherwise specified)

Isolation Characteristics (T_A = -40°C to +85°C unless otherwise specified.)

| Symbol | Characteristics | Test Conditions | Min. | Тур.* | Max. | Unit |
|------------------|--|---|------|------------------|------|------------------|
| I _{I-O} | Input-Output Insulation Leakage Current | $\label{eq:transform} \begin{array}{l} \mbox{Relative humidity} = 45\%, \\ \mbox{T}_A = 25^\circ\mbox{C}, \ t = 5\mbox{s}, \\ \mbox{V}_{I\text{-}O} = 3000 \ \mbox{VDC}^{(12)} \end{array}$ | | | 1.0* | μA |
| V _{ISO} | Withstand Insulation Test Voltage | $\begin{array}{l} RH < 50\%, T_A = 25^{\circ}C, \\ I_{I-O} \leq 2\mu A, t = 1 min.^{(12)} \end{array}$ | 2500 | | | V _{RMS} |
| R _{I-O} | Resistance (Input to Output) | $V_{I-O} = 500V^{(12)}$ | | 10 ¹² | | Ω |
| C _{I-O} | Capacitance (Input to Output) | $f = 1 MHz^{(12)}$ | | 0.6 | | pF |

*All Typicals at $V_{CC} = 5V$, $T_A = 25^{\circ}C$

Notes:

- The V_{CC} supply to each optoisolator must be bypassed by a 0.1µF capacitor or larger. This can be either a ceramic
 or solid tantalum capacitor with good high frequency characteristic and should be connected as close as possible
 to the package V_{CC} and GND pins of each device.
- 2. Each channel.
- 3. Enable Input No pull up resistor required as the device has an internal pull up resistor.
- t_{PLH} Propagation delay is measured from the 3.75mA level on the HIGH to LOW transition of the input current pulse to the 1.5 V level on the LOW to HIGH transition of the output voltage pulse.
- t_{PHL} Propagation delay is measured from the 3.75mA level on the LOW to HIGH transition of the input current pulse to the 1.5 V level on the HIGH to LOW transition of the output voltage pulse.
- 6. t_r Rise time is measured from the 90% to the 10% levels on the LOW to HIGH transition of the output pulse.
- 7. t_f Fall time is measured from the 10% to the 90% levels on the HIGH to LOW transition of the output pulse.
- 8. t_{ELH} Enable input propagation delay is measured from the 1.5V level on the HIGH to LOW transition of the input voltage pulse to the 1.5V level on the LOW to HIGH transition of the output voltage pulse.
- t_{EHL} Enable input propagation delay is measured from the 1.5V level on the LOW to HIGH transition of the input voltage pulse to the 1.5V level on the HIGH to LOW transition of the output voltage pulse.
- CM_H The maximum tolerable rate of rise of the common mode voltage to ensure the output will remain in the HIGH state (i.e., V_{OUT} > 2.0V). Measured in volts per microsecond (V/μs).
- CM_L The maximum tolerable rate of rise of the common mode voltage to ensure the output will remain in the LOW output state (i.e., V_{OUT} < 0.8V). Measured in volts per microsecond (V/μs).
- 12. Device considered a two-terminal device: Pins 1, 2, 3 and 4 shorted together, and Pins 5, 6, 7 and 8 shorted together.







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Through Hole



0.4" Lead Spacing



Surface Mount



8-Pin DIP – Land Pattern



Note:

All dimensions are in inches (millimeters)

| Ordering Informa | Ordering Information | | | | | |
|------------------|----------------------|---------------------------------------|--|--|--|--|
| Option | Example Part Number | Description | | | | |
| S | 6N137S | Surface Mount Lead Bend | | | | |
| SD | 6N137SD | Surface Mount; Tape and Reel | | | | |
| W | 6N137W | 0.4" Lead Spacing | | | | |
| V | 6N137V | VDE0884 | | | | |
| WV | 6N137WV | VDE0884; 0.4" Lead Spacing | | | | |
| SV | 6N137SV | VDE0884; Surface Mount | | | | |
| SDV | 6N137SDV | VDE0884; Surface Mount; Tape and Reel | | | | |

Marking Information

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| Definiti | ons | | | | |
|----------|--|--|--|--|--|
| 1 | Fairchild logo | | | | |
| 2 | Device number | | | | |
| 3 | VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table) | | | | |
| 4 | Two digit year code, e.g., '03' | | | | |
| 5 | Two digit work week ranging from '01' to '53' | | | | |
| 6 | Assembly package code | | | | |

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